

1 1. (Twice Amended) An electrical connector comprising a plurality of bus conductors, each
2 bus conductor of the plurality of bus conductors running through the length of the
3 connector [yet] and being electrically isolated from [one another and] other bus
4 conductors of the plurality of bus conductors, each bus conductor of the plurality of bus
5 conductors having a number of compliant contact regions [disposed at various
6 positions along their respective lengths so as] to provide electrical coupling points for
7 like contact regions of electrical devices to be received within the connector, the
8 plurality of bus conductors including [being divided into] first and second groups such
9 that across the width of the connector, [a] each bus conductor of the first group is
10 positioned [adjacent to] in an interleaved configuration with each bus conductor
11 [conductors] of the second group [that is positioned adjacent to yet another bus
12 conductor of the first group, and so on for each of the plurality of bus conductors, the]
13 and having a predetermined transmission line impedance [of any pair of adjacent bus
14 conductors, one being chosen from the first group and the other being chosen from the
15 second group, being determinable], and wherein each of the bus conductors of the first
16 group are adapted to be electrically coupled to respective signal paths associated with a
17 circuit board on which the connector is to be mounted through [only two] an electrical
18 contact element [elements regardless of the number of compliant contact regions, the
19 two electrical contact elements of each bus conductor of the first group being arranged
20 so that each is], disposed substantially near [an] each end of [its] each respective bus
21 conductor of the first group, and the bus conductors of the second group each being
22 adapted to be electrically coupled to an electrical ground plane associated with the
23 circuit board through a number of electrical contact elements disposed along each bus
24 conductor of the second group [their respective lengths, the number of electrical
25 contact elements being irrespective of the number of compliant contact regions].

1 2. A connector as in claim 1 wherein a dielectric spacer is disposed between each adjacent
2 bus conductor of the first and second groups.

1 3. A connector as in claim 2 wherein said compliant contact regions of said bus
2 conductors comprise fingers offset from respective ones of said bus conductors through
3 a bend.

1 4. A connector as in claim 2 wherein said compliant contact regions comprise elastomer-
2 backed metal regions.

1 5. A connector as in claim 1 wherein said compliant contact regions of said bus
2 conductors are made of a Beryllium-Copper (Be-Cu) alloy.

1 6. A connector as in claim 5 further comprising a dielectric spacer disposed between each
2 adjacent bus conductor of the first and second groups.

1 7. A connector as in claim 1 wherein said compliant contact regions of said bus
2 conductors comprise elastomer-backed metal regions.

1 8. A connector as in claim 1 wherein the compliant contact regions of bus conductors of
2 the first group are arranged to contact a first side of the electrical devices and the
3 compliant contact regions of bus conductors of the second group are arranged to
4 contact a second side of the electrical devices.

1 9. A connector as in claim 8 wherein the compliant contact regions of the bus conductors
2 are made of a Beryllium-Copper (Be-Cu) alloy.

- 1 10. A connector as in claim 8 wherein the compliant contact regions of the bus conductors
2 comprise elastomer-backed metal regions.
- 1 11. A connector as in claim 8 wherein the compliant contact regions of the bus conductors
2 comprise fingers offset from respective ones of the bus conductors through a bend.
- 1 12. A connector as in claim 1 wherein the signal paths comprise a plurality of traces on the
2 circuit board.
- 1 13. A connector as in claim 12 wherein the compliant contact regions of the bus conductors
2 comprise fingers offset from respective ones of the conductors through a bend.
- 1 14. A connector as in claim 12 wherein the compliant contact regions of the bus conductors
2 comprise elastomer-backed metal regions.
- 1 15. A connector as in claim 1 wherein said electrical contact elements of said bus
2 conductors of the first group comprise metal posts.
- 1 16. A connector as in claim 15 wherein said electrical contact elements of said bus
2 conductors of the second group comprise metal posts.
- 1 17. A connector as in claim 16 wherein said metal posts of said bus conductors of the second
2 group are disposed at approximately equal intervals over the lengths of each of said bus
3 conductors of said second group
- 1 18. (Amended) A socket for providing an electrical interface between a substrate and a
2 plurality of removable electronic components, the socket comprising:
3 a socket housing adapted to receive the plurality of removable electronic components;
4 and

5 a plurality of signal lines including a first group of signal lines interleaved with a
6 second group of signal lines, wherein the first group of signal lines includes a
7 first signal conductor extending through the socket housing and having a
8 predetermined impedance and first and second ends adapted to couple
9 respectively to first and second traces disposed on the substrate such that the first
10 signal conductor forms a signal transmission line between the first and second
11 traces, the first signal conductor further having a plurality of electrical contact
12 regions to couple to counterpart electrical contact regions disposed on the
13 plurality of removable electronic components, and wherein the second group of
14 signal lines includes a number of electrical contact elements disposed along the
15 length of each signal conductor of the second group of signal lines, each
16 electrical contact element being adapted to couple to a ground plane node of the
17 substrate.

1 19. The socket of claim 18 wherein additional signal lines of the first group of signal lines
2 extend through the socket housing parallel to the first signal conductor, the additional
3 signal conductors each having the predetermined impedance and first and second ends
4 adapted to couple to a respective additional pair of traces on the substrate such that
5 each additional signal conductor forms a signal transmission line between the
6 additional pair of traces, each additional signal conductor further having a plurality of
7 electrical contact regions to couple to additional counterpart electrical contact regions
8 disposed on the plurality of removable electronic components, the first signal
9 conductor and the additional signal conductors forming a signaling bus that extends
10 through the socket housing.

1 20. (Amended) The socket of claim 18 wherein the second group of signal lines include a
2 first ground conductor extending through the socket housing and disposed adjacent the
3 first signal conductor, the first ground conductor having a plurality of contact elements
4 disposed along its length to couple the first ground conductor to the ground plane of the
5 substrate.

21. (Amended) The socket of claim 20 wherein the first group of signal lines include:
additional signal conductors extending through the socket housing in a direction
parallel to the first signal conductor, the additional signal conductors each having
the predetermined impedance and first and second ends adapted to couple to a
respective additional pair of traces on the substrate such that each additional
signal conductor forms a signal transmission line between the respective
additional pair of traces, each additional signal conductor further having a
plurality of electrical contact regions to couple respectively to additional
counterpart electrical contact regions disposed on the plurality of removable
electronic components, the first signal conductor and the additional signal
conductors forming a signaling bus that extends through the socket housing;
wherein the second group of signal lines include additional ground conductors
extending through the socket housing parallel to the first ground conductor, each
of the additional ground conductors having a plurality of contact elements located
along its length to couple to a ground plane of the substrate; and
wherein signal conductors, including the first signal conductor and the additional
signal conductors, and ground conductors, including the first ground conductor
and the additional ground conductor, are disposed within the socket housing such
that each of the signal conductors is adjacent a respective one of the ground
conductors.

22. The socket of claim 21 wherein each one of the signal conductors is disposed adjacent
another one of the signal conductors.

23. The socket of claim 21 wherein the signal conductors and the ground conductors are
disposed within the socket housing such that each of signal conductor of a subset of the
signal conductors is positioned between a respective pair of the ground conductors.

1 24. The socket of claim 21 wherein the signal conductors and ground conductors are
2 disposed within the socket housing such that the contact regions of each signal
3 conductor oppose the contact regions of the adjacent ground conductor.

1 25. The socket of claim 21 wherein each signal conductor and adjacent ground conductor
2 form a signal-ground conductor pair having opposing signal and ground contact
3 regions, each pair of opposing signal and ground contact regions being positioned to
4 contact respective electrical contact elements disposed on opposing faces of a
5 respective one of the removable electronic components.

1 26. The socket of claim 25 wherein the contact regions of the signal conductors of the
2 signal-ground conductor pairs are positioned to alternately contact each of the opposing
3 faces of the respective one of the removable electronic components.

1 27. The socket of claim 26 wherein the contact regions of the ground conductors of the
2 signal-ground conductor pairs are positioned to alternately contact each of the opposing
3 faces of the respective one of the removable electronic components.

1 28. The socket of claim 20 further comprising a dielectric spacer disposed between the first
2 signal conductor and the first ground conductor.

1 29. The socket of claim 28 wherein the width of the dielectric spacer is selected to achieve
2 the predetermined impedance of the first signal conductor.

1 30. The socket of claim 28 wherein the dielectric spacer is bonded to at least one of the
2 first ground conductor and the first signal conductor.

1 31. The socket of claim 20 wherein the first signal conductor and the first ground
2 conductor are formed by respective conductive plates.

1 32. The socket of claim 18 further comprising an elastomer disposed underneath each of
2 the plurality of electrical contact regions of the first signal conductor.

1 33. (Amended) The socket of claim 18 wherein the additional signal conductors of the first
2 group extend through the socket housing parallel to the first signal conductor, the
3 additional signal conductors each having the predetermined impedance and first and
4 second ends adapted to couple to a respective additional pair of traces on the substrate
5 such that each additional signal conductor forms a signal transmission line between the
6 additional pair of traces, each additional signal conductor further having a plurality of
7 electrical contact regions to couple to additional counterpart electrical contact regions
8 on the plurality of removable electronic components; and wherein the socket further
9 comprises a plurality of elastomers extending through the socket housing in a direction
10 transverse to the first signal conductor and the additional signal conductors, each of the
11 elastomers extending beneath at least one electrical contact region of each of the
12 additional signal conductors and beneath least one electrical contact region of the first
13 signal conductor.

1 34. (Amended) The socket of claim 33 wherein each of the elastomers of the plurality of
2 elastomers is formed from a dielectric material to maintain electrical isolation between
3 the signal conductors, including the first signal conductor and the additional signal
4 conductors.

1 35. The socket of claim 18 wherein the predetermined impedance of the first signal
2 conductor is selected to match a termination impedance on the substrate.

1 36. The socket of claim 35 wherein the termination impedance on the substrate is a resistor
2 coupled to the second trace.

1 37. The socket of claim 18 wherein each of the removable electronic components is a
2 daughter card and the socket housing is adapted to receive a plurality of the daughter
3 cards.

1 38. The socket of claim 18 wherein each of the removable electronic components is an
2 integrated circuit device and the socket housing is adapted to receive a plurality of the
3 integrated circuit devices.

1 39. The socket of claim 18 wherein the first and second ends of the first signal conductor
2 include posts adapted to fit into respective holes in the substrate.

1 40. (Amended) An electrical connector comprising:
2 a connector housing having a plurality of slots to receive removable electronic
3 components;
4 signal conductors that extend through the connector housing to form a signaling bus,
5 the signal conductors including contact regions to electrically couple the
6 removable electronic components to the signaling bus, each of the signal
7 conductors having first and second ends to couple to respective signal traces on a
8 substrate and having a predetermined impedance; and
9 ground conductors that extend through the connector housing parallel to and
10 interleaved with the signal conductors, the ground conductors each including a
11 plurality of contact regions to electrically couple to a ground reference of the
12 substrate, the ground conductors and signal conductors being disposed within the
13 connector housing such that each of the signal conductors is adjacent at least one
14 of the ground conductors.

1 41. The electrical connector of claim 40 wherein the predetermined impedance is selected
2 to match a termination impedance of the signaling bus.

1 42. The electrical connector of claim 41 wherein the termination impedance is formed by a
2 plurality of resistors coupled respectively to the signal traces on the substrate.

1 43. The electrical connector of claim 40 wherein a dielectric spacer is positioned between
2 each signaling conductor and adjacent ground conductor.

1 44. The electrical connector of claim 40 wherein each of the signal conductors forms a
2 transmission line between the respective signal traces when coupled thereto.

1 45. The electrical connector of claim 40 wherein each of the signal conductors is adapted to
2 be coupled to the substrate only at the first and second ends, and wherein each of the
3 ground conductors includes at least three contact regions to couple to the ground
4 reference of the substrate.

1 46. The electrical connector of claim 40 wherein the contact regions of the signal
2 conductors and the contact regions of the ground conductors each extend into the slots
3 of the connector housing to contact counterpart contact regions of the removable
4 electronic components when the removable electronic components are inserted into the
5 slots of the connector housing.

1 47. (Amended) A signaling system comprising:
2 a substrate including a first plurality of signal conducting traces and a second plurality
3 of signal conducting traces;
4 a socket mounted to the substrate and including a housing with slots formed therein,
5 the socket further including a plurality of signal conductors that extend through
6 the housing in a direction transverse to the slots, each signal conductor of the
7 plurality of signal conductors having a predetermined impedance and being
8 coupled to form a transmission line between a respective one of the first plurality
9 of signal conducting traces on the substrate and a respective one of the second
10 plurality of signal conducting traces on the substrate, and wherein the plurality of

11 signal conductors include a group of signaling lines that are interleaved with a
12 group of ground lines, each ground line of the group of ground lines including a
13 plurality of electrical contact elements electrically coupled to a ground plane; and
14 a plurality of electronic components removably inserted into the slots of the socket
15 housing, each of the electronic components including a plurality of contact
16 regions that respectively contact the plurality of signal conductors.

1 48. The signaling system of claim 47 wherein each of the plurality of electronic
2 components comprises a printed circuit board having an integrated circuit device
3 mounted thereon.

1 49. The signaling system of claim 48 wherein the integrated circuit device is a
2 semiconductor memory device.

1 50. The signaling system of claim 49 wherein the semiconductor memory device is a
2 dynamic random access memory device.

1 51. The signaling system of claim 49 further comprising a memory controller mounted to
2 the substrate and coupled to the first plurality of signal conducting traces, the memory
3 controller being adapted to transmit signals to the semiconductor memory device via
4 the first plurality of signal conducting traces.

1 52. The signaling system of claim 47 wherein each of the electronic components comprises
2 an integrated circuit device.

1 53. The signaling system of claim 52 wherein the integrated circuit device is a
2 semiconductor memory device.

1 54. The signaling system of claim 53 wherein the semiconductor memory device is a
2 dynamic random access memory device.

1 55. The signaling system of claim 53 further comprising a memory controller mounted to
2 the substrate and coupled to the first plurality of signal conducting traces, the memory
3 controller being adapted to transmit signals to the semiconductor memory device via
4 the first plurality of signal conducting traces.

1 56. The signaling system of claim 47 further comprising a plurality of termination elements
2 coupled respectively to the second plurality of signal conducting traces.

1 57. The signaling system of claim 56 wherein the predetermined impedance of each signal
2 conductor of the plurality of signal conductors is selected to match the impedance of a
3 respective one of the termination elements.

1 58. The signaling system of claim 47 wherein each ground line of the group of ground lines
2 includes a plurality of contact regions to contact the plurality of electronic components.

1 59. (Amended) The signaling system of claim 58 wherein each ground line of the group of
2 ground lines is disposed within the housing adjacent at least one of the signaling lines
3 of the group of signaling lines, each ground line of the group of ground lines and each
4 signaling line of the group of signaling lines forming a plurality of signal-ground
5 conductor pairs.

1 60. The signaling system of claim 59 wherein each of the signal-ground conductor pairs
2 contacts a first electrical component of the plurality of electrical components on
3 opposing faces of the first electrical component.

1 61. The signaling system of claim 60 wherein each of the signal-ground conductor pairs are
2 disposed within the socket housing such that the plurality of signal conductors
3 alternately contact a first face and a second face of the opposing faces of the first
4 component.

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1 62. The signaling system of claim 61 wherein each of the signal-ground conductor pairs are
2 disposed within the socket housing such that the plurality of ground conductors alternately
3 contact the first face and the second face of the opposing faces of the first component.
